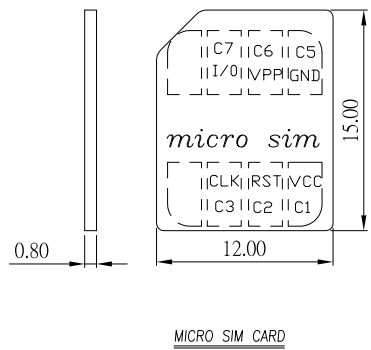
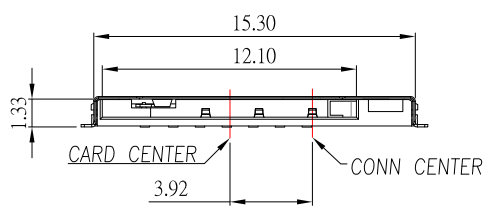
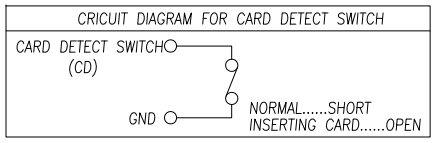


PCB LAYOYT



| SIM pin Assignment | |
|--------------------|------|
| PIN# | Name |
| C1 | VCC |
| C2 | RST |
| C3 | CLK |
| C5 | GND |
| C6 | VPP |
| C7 | I/O |

- Material:**
- Housing: LCP
 - Contact: Copper Alloy
 - Shell: SUS
- Finish:**
- Contact: Plated Gold in Mating Area ;
Gold Plated on Solder Balls ;
Nickel under plated overall
 - Shell: Nickel under Plated surface laye



| ITEM NO. | DESCRIPTION | DRAWN | DATE |
|----------|-------------|-------|--------|
| 3 | 更新樣式 | Jack | 102820 |
| 2 | 更新尺寸 | Jack | 101518 |
| 1 | 更新樣式 | Jack | 101218 |

CONTACT 建倚科技股份有限公司
CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS OTHERWISE STATED :

| | |
|---------------|-------|
| Up to 5 | ±0.2 |
| Above 5 ~ 15 | ±0.3 |
| Above 15 ~ 30 | ±0.4 |
| Above 30 ~ 50 | ±0.5 |
| Angle | ±0.3° |

3RD. ANGEL'S

UNITS MM

| | | | | |
|--------------|----------|-----------|-----------|--|
| DRAWN BY: | DATE | MAT'L | TITLE | CONNECTOR |
| Jack Lu | 10/28/20 | | CONNECTOR | |
| CHECKED BY: | DATE | FINISH | MODLE | MICRO SIM CARD PUSH PUSH 7PIN 1.45H 帶CD PIN(防呆型) |
| Jacky Chen | 10/28/20 | | | |
| APPROVED BY: | DATE | SCALE | DWG NO. | MSIM-S3071-A1-S304 |
| Tony Kao | 10/28/20 | 1 : 1 | | |
| | | SHEET NO. | PART NO. | MSIM-S3071-A1-S304 |
| | | 1 of 1 | | |
| | | | SIZE | A4 |
| | | | VER | R3 |